

AND7GA

InGaN Ultra Bright Green Light Low Profile Surface Mount Package

Features

- 0.40 mm height
- RoHS Compliant
- Compatible with automatic placement equipment.
- Compatible w/ infrared & vapor phase reflow solder process.

Applications

- Backlighting in auto dashboard & switch.
- Flat backlight for LCD, switch & symbol.
- General use for miniature applications.

Maximum Ratings $(T_a = 25^{\circ}C)$

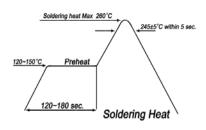
Characteristics	Symbol	Rating	Unit
Forward Current	I _F	30	mA
Reverse Voltage	V _R	5	٧
Power Dissipation	P _D	110	mW
Operating Temp. Range	T _{Opr}	-40~ +85	°C
Storage Temp. Range	T _{Stg}	-40~ +90	°C
Soldering Temp. (for 5 seconds)	T _{Sol}	260	°C
Electrostatic Discharge	ESD	150	V
Peak Forward Current (Duty 1/10 @ 1KHz)	I _F	100	mA

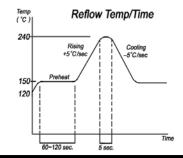
Electro-Optical Characteristics (T_a = 25°C)

Characteristics	Symbol	Test Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	V _F	I _F = 5 mA	_	3.0	_	V
Forward Voltage	V _F	I _F = 20 mA	_	3.5	4.3	V
Reverse Current	I _R	V _R = 5 V	-	-	50	μΑ
Luminous Intensity	I _V	I _F = 5 mA	_	60	_	mcd
Luminous Intensity	I _V	I _F = 20 mA	112	180	_	mcd
Peak Wavelength	λ_{P}	I _F = 20 mA	-	518	_	nm
Spectral Line Half Width	Δλ	I _F = 20 mA	-	36	_	nm
Dominant Wavelength	λd	I _F = 20 mA	_	525	_	nm
Full Viewing Angle	2 θ 1/2	I _F = 20 mA	_	120	_	degree

Precautions:

- 1. Static electricity and surge can damage the LED. It is recommended to use wrist band or antistatic gloves when handling the LED.
- 2. Recommended solder condition:





Product specifications contained herein may be changed without prior notice. It is therefore advisable to contact Purdy Electronics before proceeding with the design of equipment incorporating this product.